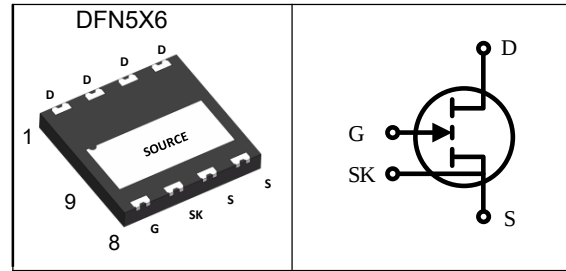


# 650V GaN Enhancement-mode Power Transistor

## Features

- Enhancement mode transistor-Normally off power switch
- Ultra high switching frequency
- No reverse-recovery charge
- Low gate charge, low output charge
- RoHS, Pb-free-compliant

## Pin Description



## Applications

- AC-DC converters
- DC-DC converters
- Totem pole PFC
- Fast battery charging
- High density power conversion

|                  |      |    |
|------------------|------|----|
| $V_{DSS}$        | 650  | V  |
| $R_{DS(ON)-Typ}$ | 140  | mΩ |
| $I_D$            | 11.5 | A  |

## Absolute Maximum Ratings( $T_C=25^{\circ}C$ , Unless Otherwise Noted)

| Symbol          | Parameter                       | Value      | Unit |
|-----------------|---------------------------------|------------|------|
| $V_{DSS}$       | Drain-Source Voltage            | 650        | V    |
| $V_{GSS}$       | Gate source voltage, continuous | -1.4 to +7 | V    |
| $V_{GSS,pulse}$ | Gate source voltage, pulsed     | ±20        | V    |
| $T_J$           | Maximum Junction Temperature    | -55 to 150 | °C   |
| $T_{STG}$       | Storage Temperature Range       | -55 to 150 | °C   |
| $I_{D, pulse}$  | Pulse Drain Current Tested      | 20.5       | A    |
| $I_D$           | Continuous Drain Current        | 11.5       | A    |
| $P_D$           | Maximum Power Dissipation       | 84         | W    |

## Thermal Characteristics

| Symbol          | Parameter                              | Value | Unit |
|-----------------|----------------------------------------|-------|------|
| $R_{\theta JA}$ | Thermal Resistance-Junction to Ambient | 35.9  | °C/W |
| $R_{\theta JC}$ | Thermal Resistance-Junction to Case    | 1.47  | °C/W |

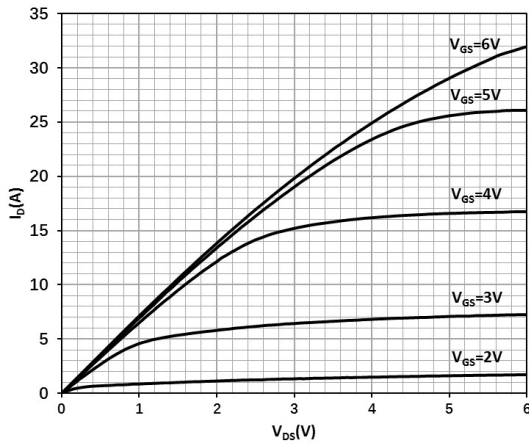
**650V GaN Enhancement-mode Power Transistor**
**Electrical Characteristics** ( $T_J=25^{\circ}\text{C}$ , Unless Otherwise Noted)

| Symbol                            | Parameter                                    | Test Conditions                                                                                            | Min | Typ  | Max  | Unit |
|-----------------------------------|----------------------------------------------|------------------------------------------------------------------------------------------------------------|-----|------|------|------|
| Static Electrical Characteristics |                                              |                                                                                                            |     |      |      |      |
| BV <sub>DSS</sub>                 | Drain-Source Breakdown Voltage               | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA                                                                 | 650 | ---  | ---  | V    |
| I <sub>DSS</sub>                  | Zero Gate Voltage Drain Current              | V <sub>DS</sub> =650V, V <sub>GS</sub> =0V                                                                 | --- | 0.45 | 20   | uA   |
| V <sub>GS(th)</sub>               | Gate Threshold Voltage                       | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =12.2mA                                                  | 1.2 | 1.7  | 2.5  | V    |
| I <sub>GSS</sub>                  | Gate Leakage Current                         | V <sub>GS</sub> =6V, V <sub>DS</sub> =0V                                                                   | --- | 60   | ---  | uA   |
| R <sub>DS(ON)</sub>               | Drain-Source On-state Resistance             | V <sub>GS</sub> =6V, I <sub>D</sub> =3.9A                                                                  | --- | 140  | 190  | mΩ   |
| Dynamic Characteristics           |                                              |                                                                                                            |     |      |      |      |
| C <sub>iss</sub>                  | Input Capacitance                            | V <sub>DS</sub> =400V,<br>V <sub>GS</sub> =0V,<br>Freq.=1MHz                                               | --- | 96   | ---  | pF   |
| C <sub>oss</sub>                  | Output Capacitance                           |                                                                                                            | --- | 30   | ---  |      |
| C <sub>rss</sub>                  | Reverse Transfer Capacitance                 |                                                                                                            | --- | 0.5  | ---  |      |
| C <sub>o(er)</sub>                | Effective output capacitance, energy related | V <sub>DS</sub> =0 to 400V,<br>V <sub>GS</sub> =0V                                                         | --- | 43   | ---  | pF   |
| C <sub>o(tr)</sub>                | Effective output capacitance, time related   |                                                                                                            | --- | 60   | ---  |      |
| Q <sub>OSS</sub>                  | Output charge                                | V <sub>DS</sub> =0 to 400V,V <sub>GS</sub> =0V                                                             | --- | 24.5 | ---  | nC   |
| T <sub>d(on)</sub>                | Turn-on Delay Time                           | V <sub>DS</sub> =400V,V <sub>GS</sub> =6V,<br>I <sub>D</sub> =8A,R <sub>on</sub> =10Ω,R <sub>off</sub> =2Ω | --- | 1.4  | ---  | nS   |
| T <sub>r</sub>                    | Turn-on Rise Time                            |                                                                                                            | --- | 4    | ---  |      |
| T <sub>d(off)</sub>               | Turn-off Delay Time                          |                                                                                                            | --- | 1.7  | ---  |      |
| T <sub>f</sub>                    | Turn-off Fall Time                           |                                                                                                            | --- | 4    | ---  |      |
| Q <sub>g</sub>                    | Total Gate Charge                            | V <sub>DS</sub> =400V,V <sub>GS</sub> =6V, I <sub>D</sub> =3.9A                                            | --- | 2.8  | ---  | nC   |
| Q <sub>gs</sub>                   | Gate-Source Charge                           |                                                                                                            | --- | 0.3  | ---  |      |
| Q <sub>gd</sub>                   | Gate-Drain Charge                            |                                                                                                            | --- | 1.1  | ---  |      |
| Source-Drain Characteristics      |                                              |                                                                                                            |     |      |      |      |
| V <sub>SD</sub>                   | Diode Forward Voltage                        | I <sub>S</sub> =3.9A, V <sub>GS</sub> =0V                                                                  | --- | 2.6  | ---  | V    |
| I <sub>S, pulse</sub>             | Pulsed current, reverse                      | V <sub>GS</sub> = 6V; t <sub>PULSE</sub> =10 μs                                                            | --- | ---  | 20.5 | A    |
| t <sub>rr</sub>                   | Reverse Recovery Time                        | I <sub>S</sub> =3.9A,V <sub>DS</sub> =400V                                                                 | --- | 0    | ---  | nS   |
| Q <sub>rr</sub>                   | Reverse Recovery Charge                      |                                                                                                            | --- | 0    | ---  | nC   |
| I <sub>rrm</sub>                  | Peak reverse recovery current                |                                                                                                            | --- | 0    | ---  | A    |

# 650V GaN Enhancement-mode Power Transistor

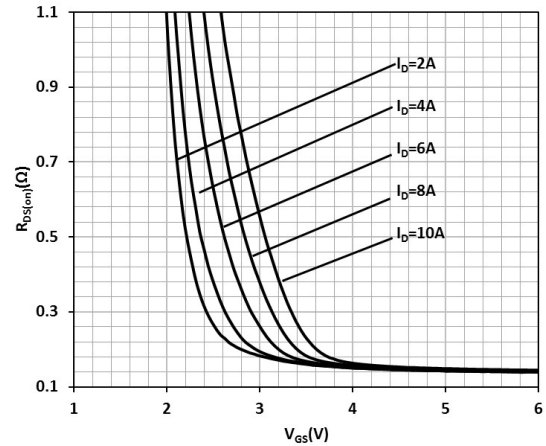
## Typical Characteristics

Figure 1 Typ. output characteristics



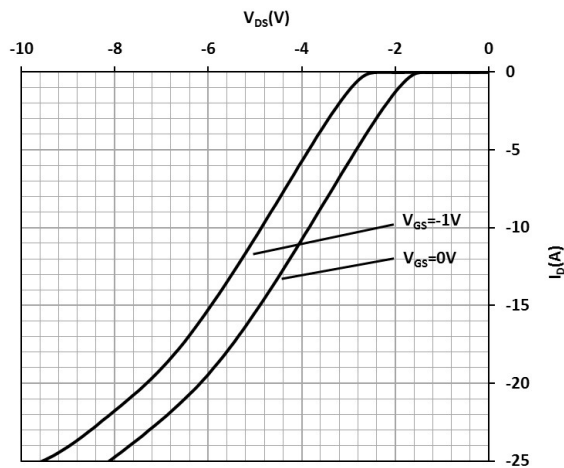
$$I_D = f(V_{DS}, V_{GS}); T_J = 25^\circ\text{C}$$

Figure 2 Typ. Drain-source on-state resistance



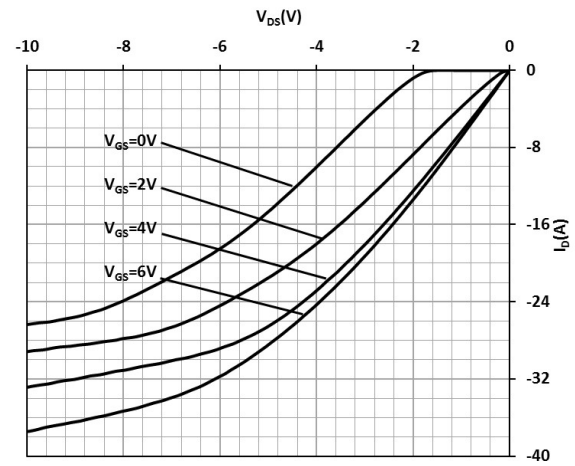
$$R_{DS(on)} = f(I_D, V_{GS}); T_J = 25^\circ\text{C}$$

Figure 3 Typ. channel reverse characteristics



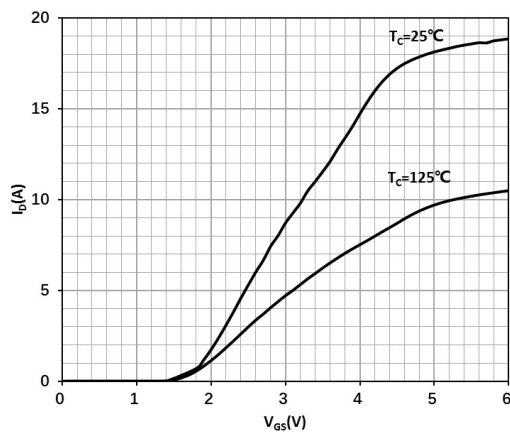
$$I_D = f(V_{DS}, V_{GS}); T_J = 25^\circ\text{C}$$

Figure 4 Typ. channel reverse characteristics



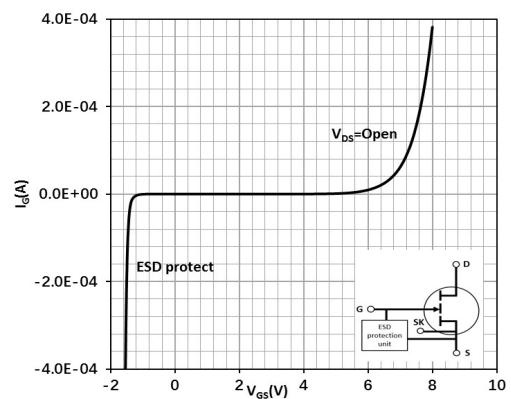
$$I_D = f(V_{DS}, V_{GS}); T_J = 25^\circ\text{C}$$

Figure 5 Typ. transfer characteristics



$$I_D = f(V_{GS}); V_{DS} = 3\text{ V}$$

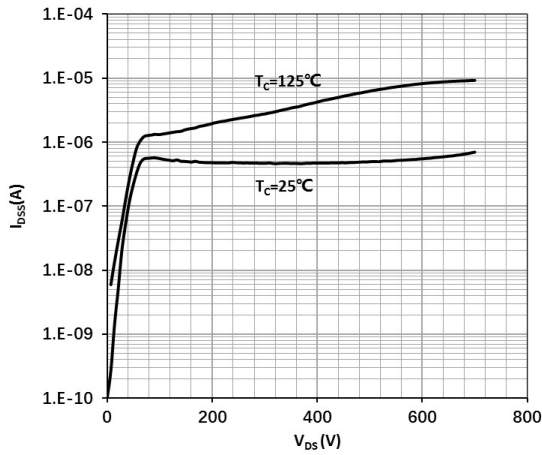
Figure 6 Typ. Gate-to-Source leakage



$$I_G = f(V_{GS}); I_G \text{ reverse turn on by ESD unit}$$

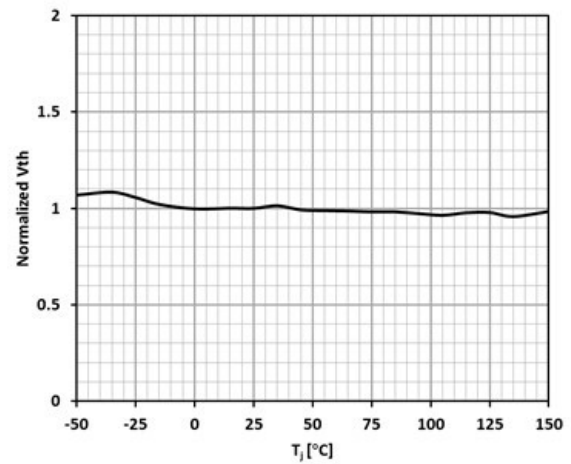
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Figure 7 Drain-source leakage characteristics



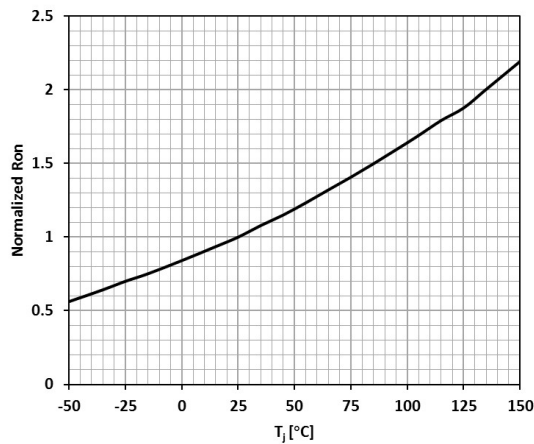
$$I_{DSS} = f(V_{DS}); V_{GS} = 0 \text{ V}$$

Figure 8 Gate threshold voltage



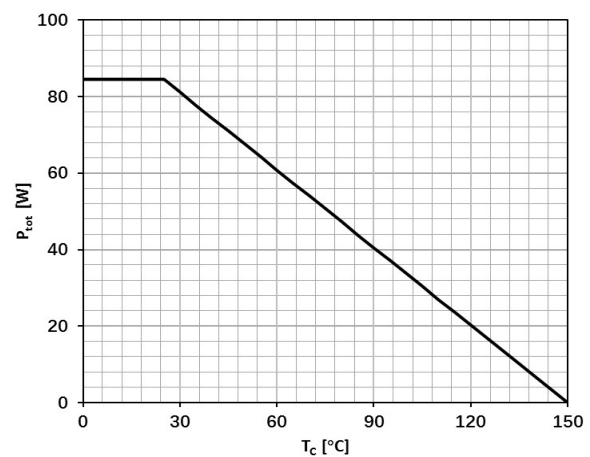
$$V_{TH} = f(T_J); V_{GS} = V_{DS}; I_D = 12.2 \text{ mA}$$

Figure 9 Drain-source on-state resistance



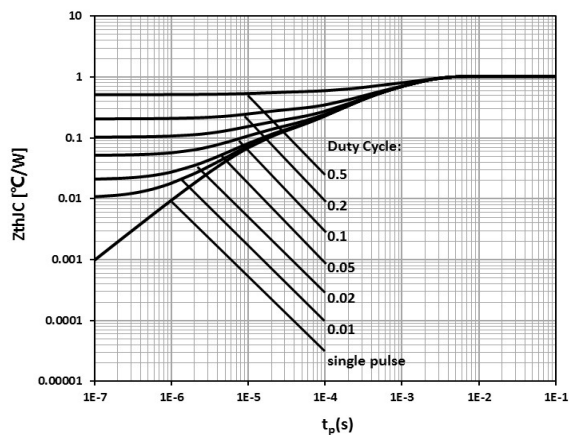
$$R_{DS(on)} = f(T_J); I_D = 3.9 \text{ A}; V_{GS} = 6 \text{ V}$$

Figure 10 Power dissipation



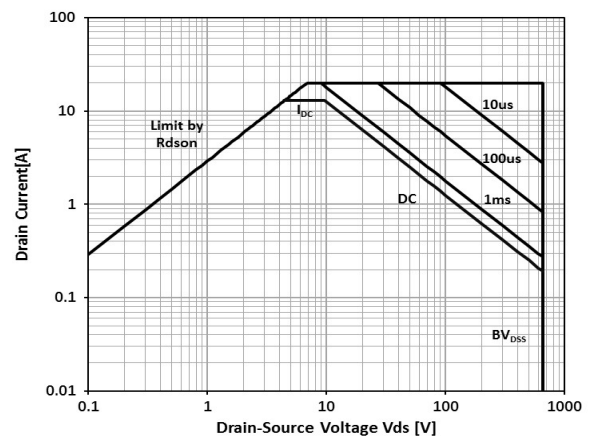
$$P_{tot} = f(T_C)$$

Figure 11 Max.transient thermal impedance



$$Z_{thJC} = f(t_p, D)$$

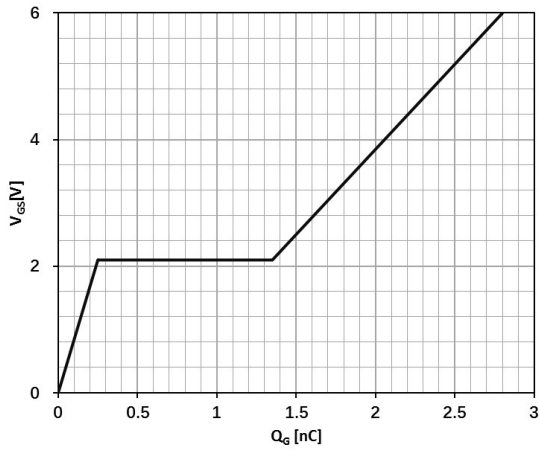
Figure 12 Safe operating area



$$I_D = f(V_{DS}); T_C = 25 \text{ °C}$$

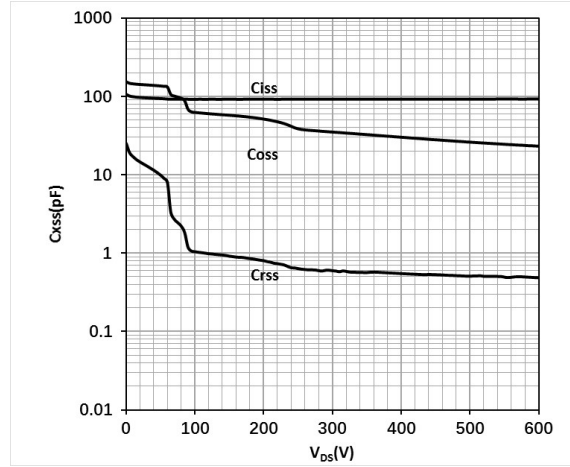
**650V GaN Enhancement-mode Power Transistor**

Figure 13 Typ. gate charge



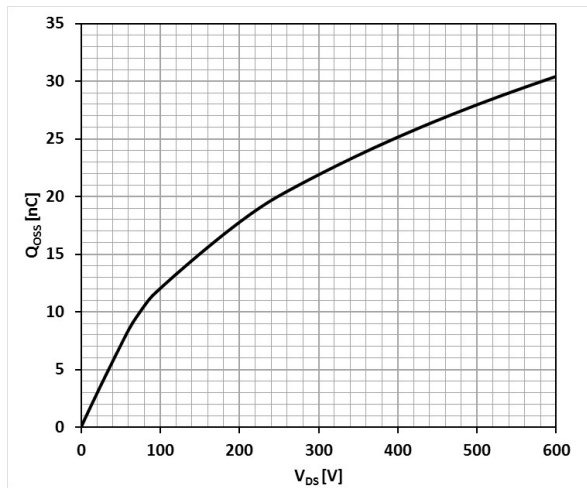
$$V_{GS} = f(Q_G); V_{DCLINK} = 400 \text{ V}; I_D = 5 \text{ A}$$

Figure 14 Typ. capacitances



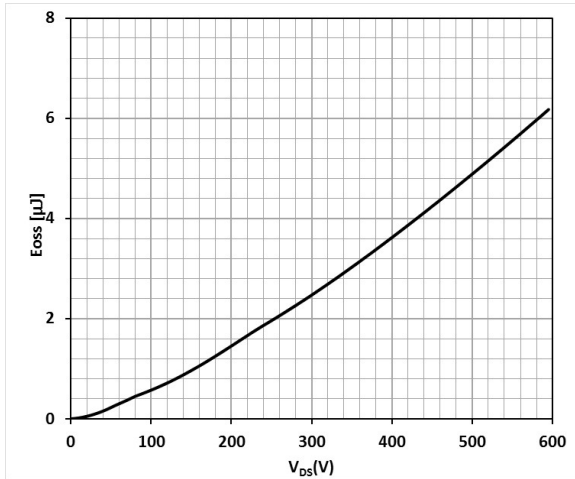
$$C_{XSS} = f(V_{DS}); \text{Freq.} = 100 \text{ kHz}$$

Figure 15 Typ. output charge



$$Q_{OSS} = f(V_{DS}); \text{Freq.} = 100 \text{ kHz}$$

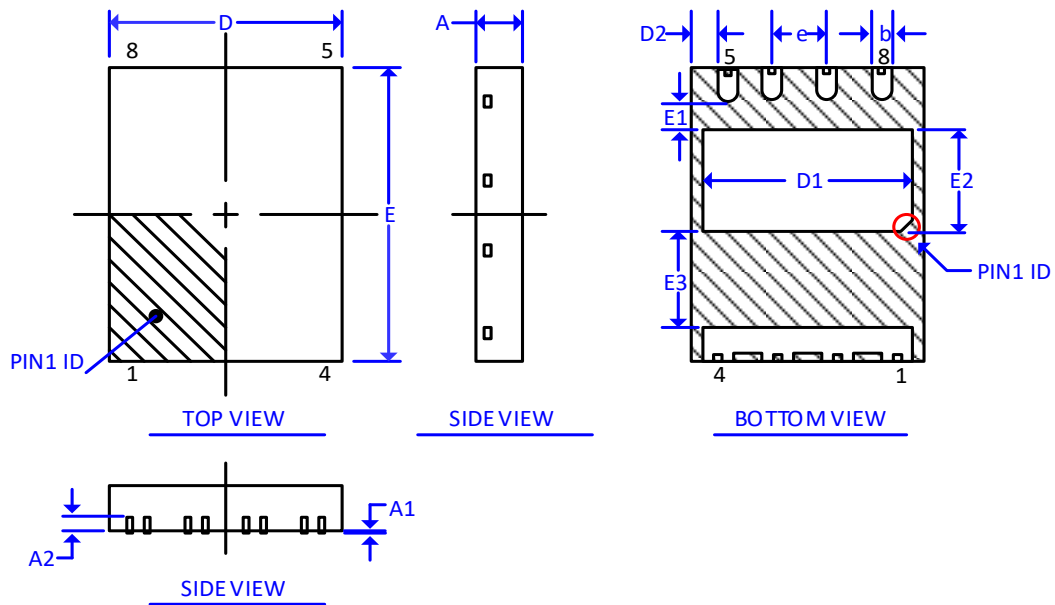
16 Typ. Coss stored Energy



$$E_{OSS} = f(V_{DS}); \text{Freq.} = 100 \text{ kHz}$$

# 650V GaN Enhancement-mode Power Transistor

## DFN5X6 Package Outline Dimensions



| SYMBOL | DIMENSION  |           |      | SYMBOL | DIMENSION  |       |       |
|--------|------------|-----------|------|--------|------------|-------|-------|
|        | MIN        | NOM       | MAX  |        | MIN        | NOM   | MAX   |
| A      | 0.80       | 0.90      | 1.00 | E      | 6.00 B.S.C |       |       |
| A1     | 0.00       | 0.02      | 0.05 | E1     | 0.40       | 0.50  | 0.60  |
| A2     | ---        | 0.203 ref | ---  | E2     | 1.95       | 2.05  | 2.15  |
| b      | 0.40       | 0.45      | 0.50 | E3     | ---        | 2.1   | ---   |
| D      | 5.00 B.S.C |           |      | e      | 1.27 B.S.C |       |       |
| D1     | 4.16       | 4.26      | 4.36 | L      | 0.575      | 0.675 | 0.775 |
| D2     | 0.27       | 0.37      | 0.47 |        |            |       |       |